

**SPECIFICATION FOR APPROVAL****SIG252012-XXX Sealed Choke Coil****1. Features**

Low profile : 2.5mm x 2.0mm x 1.2mm

Low coil resistance with large currents.

High magnetic shield construction should actualize high resolution for EMC protection.

100% lead (Pb) free meet RoHS standard

2. Application

Cellular phones, LCD displays, HDDs, DVCs, DSCs, PDAs etc..

3. Type Designation

SIG 252012 – XXX
(1) (2) (3)

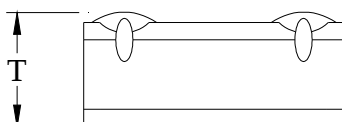
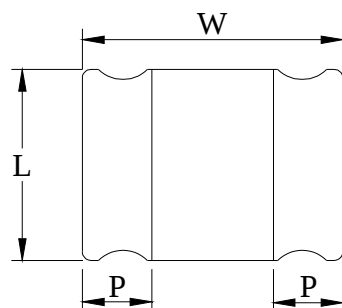
Where (1) Series No :

(2) Size :

252012 = 2.5mm x 2.0mm x 1.2mm

(3) Inductance Value :

3R3 = 3.3 μ H

4. Outline Dimensions

Code	Dimensions (mm)
L	2.0 ± 0.1
W	2.5 ± 0.1
T	1.2 Max
P	0.4 ± 0.2

Note: This graph is only regard to dimensions spec. For outer appearance, please refer to actual product.



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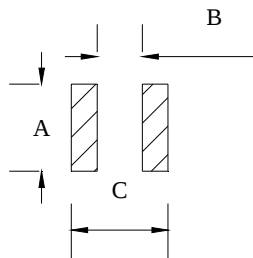
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5. Recommend Land Pattern Dimensions

The customer shall determine the land dimensions shown above after confirming and safety.



A	2.1
B	0.8
C	2.6

Unit : mm

6. Specifications

Part Number	L0 Inductance (μ H) @ (0A)	R _{dc} (m Ω)		Heat Rating Current DC Amps. Idc (A)		Saturation Current DC Amps. Isat (A)	
		Typical	Maximum	Typical	Maximum	Typical	Maximum
SIG252012-R22	0.22	31	38	3.50	3.15	4.50	4.05
SIG252012-R47	0.47	47	56	2.20	1.98	3.70	3.33
SIG252012-R50	0.50	56	67	2.15	1.93	3.50	3.15
SIG252012-R68	0.68	65	78	2.10	1.89	3.40	3.06
SIG252012-1R0	1.0	73	88	1.80	1.62	2.70	2.43
SIG252012-1R2	1.2	93	112	1.60	1.44	2.35	2.11
SIG252012-1R5	1.5	105	126	1.50	1.35	2.20	1.98
SIG252012-2R2	2.2	129	155	1.30	1.17	2.00	1.80
SIG252012-3R3	3.3	227	272	1.00	0.90	1.60	1.44
SIG252012-4R7	4.7	338	406	0.81	0.73	1.30	1.17
SIG252012-5R6	5.6	375	450	0.72	0.65	1.15	1.03
SIG252012-6R8	6.8	510	612	0.66	0.60	1.10	0.99
SIG252012-8R2	8.2	590	708	0.62	0.55	0.95	0.85
SIG252012-100	10.0	630	756	0.59	0.53	0.90	0.81
SIG252012-220	22.0	2,170	2,604	0.30	0.27	0.50	0.45

* : If you require another part number please contact with us.

** : Inductance Tolerance $\pm 20\%$

Note 1. : All test data is referenced to 25°C ambient.

Note 2. : Idc : DC current (A) that will cause an approximate ΔT of 40°C

Note 3. : Isat : DC current (A) that will cause L0 to drop approximately 30%

Note 4. : Operating Temperature Range -55°C to + 125°C

Note 5. : The part temperature (ambient + temp rise) should not exceed 125°C under worse case operating conditions. Circuit design , component placement, PWB trace size and thickness, airflow and other cooling provision all affect the part temperature. Part temperature should be verified in the end application.

Note 6. : The rated current as listed is either the saturation current or the heating current depending on which value is lower.



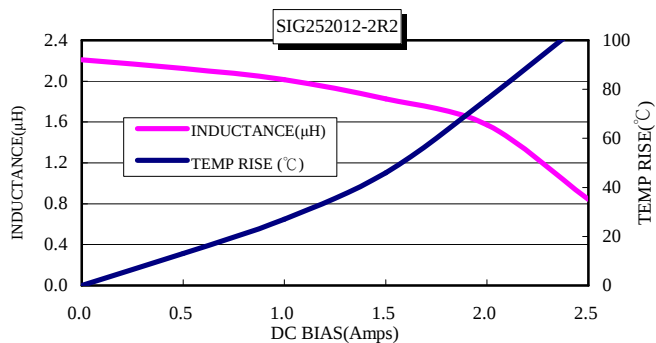
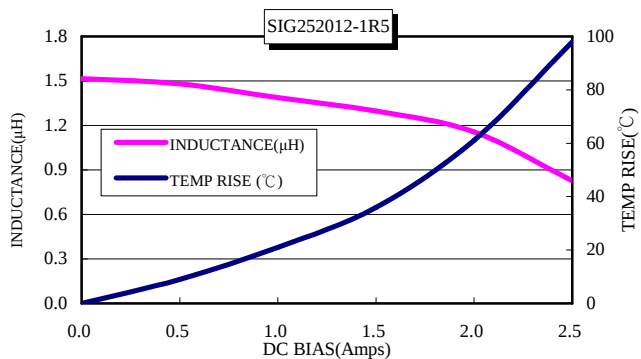
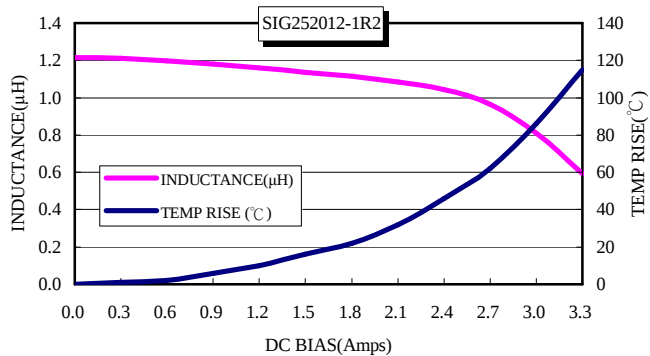
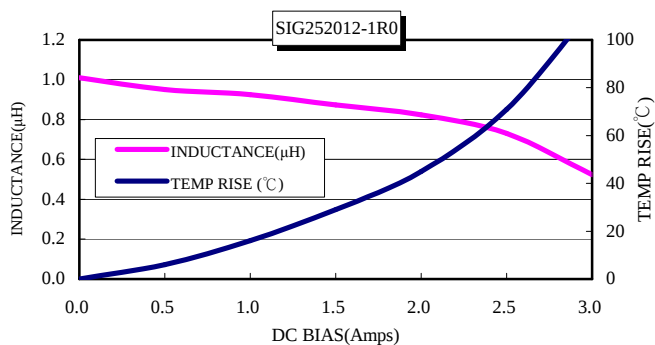
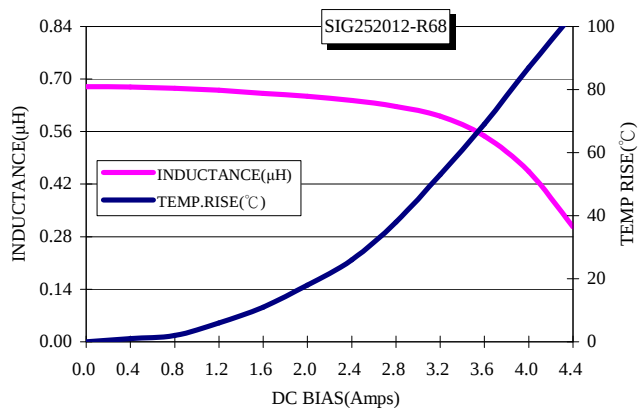
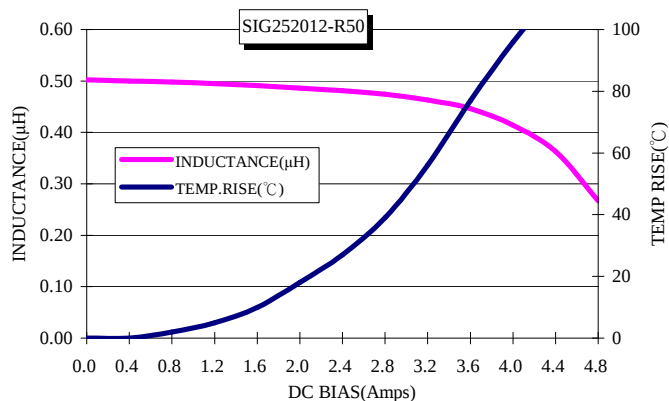
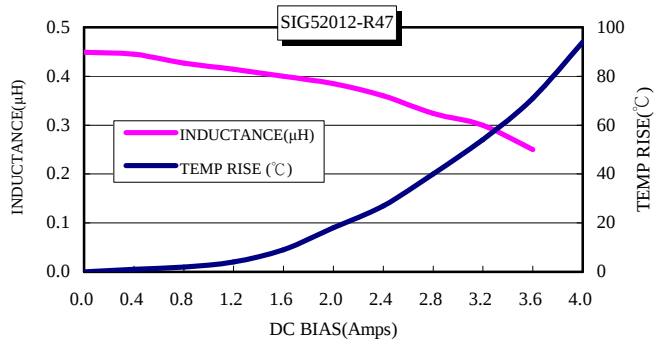
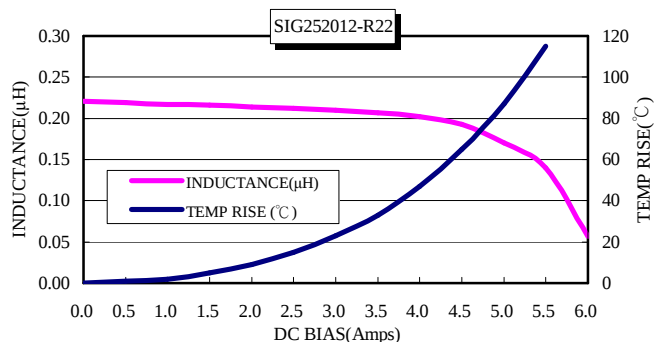
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6-1 Current Characteristic





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